



SPECIFICATION

(Reference sheet)

· Supplier : Samsung electro-mechanics · Samsung P/N : CL21B682KCANNNC

Product : Multi-layer Ceramic Capacitor

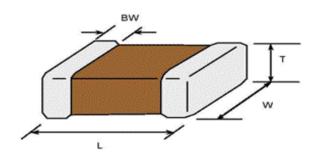
Description : CAP, 6.8nF, 100V, ±10%, X7R, 0805

A. Samsung Part Number

<u>CL</u> <u>21</u> <u>B</u> <u>682</u> <u>K</u> <u>C</u> <u>A</u> <u>N</u> <u>N</u> <u>N</u> <u>C</u> ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪

1	Series	Samsung Multi-layer Ceramic Capacitor				
2	Size	0805 (inch code)	L: 2.00	± 0.10 mm	W : 1.25 ± 0.10 mr	n
3	Dielectric	X7R	8	Inner electrode	Ni	
4	Capacitance	6.8 nF		Termination	Cu	
⑤	Capacitance	±10 %		Plating	Sn 100%	(Pb Free)
	tolerance		9	Product	Normal	
6	Rated Voltage	100 V	10	Special	Reserved for	future use
7	Thickness	$0.65 \pm 0.10 \text{ mm}$	11)	Packaging	Cardboard Type, 7" reel	

B. Structure & Dimension



Samsung P/N	Dimension(mm)				
Samsung F/N	L	W	Т	BW	
CL21B682KCANNNC	2.00 ± 0.10	1.25 ± 0.10	0.65 ± 0.10	0.50 +0.20/-0.30	

C. Samsung Reliablility Test and Judgement Condition

Tan δ (DF) 0	hin specified tolerance 0.025 max. 0.00Mohm or 500Mohm×µF	1 kHz ±10% / 1.0±0.2 Vrms *A capacitor prior to measuring the capacitance is heat treated at 150 ℃+0/-10 ℃ for 1 hour and maintained in ambient air for 24+2 hours		
Tan δ (DF) 0		treated at 150 $^{\circ}\text{C}$ +0/-10 $^{\circ}\text{C}$ for 1hour and maintained in		
Insulation 10,0	000Mohm or 500Mohm× 4/F			
1	oodivioriiii or oodivioriiii//	Rated Voltage 60±5 sec.		
Resistance Wh	nichever is smaller			
Appearance No a	abnormal exterior appearance	Microscope (×10)		
Withstanding No o	dielectric breakdown or	200% of the rated voltage		
Voltage med	chanical breakdown			
Temperature X7F	7			
Characteristics (Fro	om -55 $^{\circ}$ to 125 $^{\circ}$, Capacitance change s	should be within ±15%)		
Adhesive Strength No	peeling shall be occur on the	500g·f, for 10±1 sec.		
of Termination term	ninal electrode			
Bending Strength Cap	pacitance change: within ±12.5%	Bending to the limit (1mm)		
		with 1.0mm/sec.		
Solderability Mor	re than 95% of terminal surface	SnAg3.0Cu0.5 solder		
is to	be soldered newly	245±5°C, 3±0.3sec.		
		(preheating : 80~120°C for 10~30sec.)		
Resistance to Cap	pacitance change: within ±7.5%	Solder pot : 270±5°C, 10±1sec.		
Soldering Heat Tan	ι δ, IR : initial spec.			
Vibration Test Cap	pacitance change: within ±5%	Amplitude: 1.5mm		
Tan	ι δ, IR : initial spec.	From 10Hz to 55Hz (return : 1min.)		
		2hours × 3 direction (x, y, z)		
Moisture Cap	pacitance change: within ±12.5%	With rated voltage		
Resistance Tan	οδ: 0.05 max	40±2°C, 90~95%RH, 500+12/-0hrs		
IR :	500Mohm or 25Mohm × μ F			
	Whichever is smaller			
High Temperature Cap	pacitance change: within ±12.5%	With 200% of the rated voltage		
Resistance Tan	οδ: 0.05 max	Max. operating temperature		
IR :	1,000Mohm or 50Mohm × μ F	1,000+48/-0hrs		
	Whichever is smaller			
Temperature Cap	pacitance change: within ±7.5%	1 cycle condition		
Cycling Tan	ι δ, IR : initial spec.	Min. operating temperature → 25°C		
		→ Max. operating temperature → 25°C		
		5 cycle test		

X The reliability test condition can be replaced by the corresponding accelerated test condition.

D. Recommended Soldering method:

Reflow (Reflow Peak Temperature :250 °C, 6 sec max.)



 \triangle Product specifications included in the specifications are effective as of March 1, 2013.

Please be advised that they are standard product specifications for reference only.

We may change, modify or discontinue the product specifications without notice at any time.

So, you need to approve the product specifications before placing an order.

Should you have any question regarding the product specifications,

please contact our sales personnel or application engineers.

- Disclaimer & Limitation of Use and Application -

The products listed in this Specification sheet are **NOT** designed and manufactured for any use and applications set forth below.

Please note that any misuse of the products deviating from products specifications or information provided in this Spec sheet may cause serious property damages or personal injury.

We will **NOT** be liable for any damages resulting from any misuse of the products, specifically including using the products for high reliability applications as listed below.

If you have any questions regarding this 'Limitation of Use and Application', you should first contact our sales personnel or application engineers.

- ① Aerospace/Aviation equipment
- ② Automotive or Transportation equipment (vehicles, trains, ships, etc)
- 3 Medical equipment
- Military equipment
- 5 Disaster prevention/crime prevention equipment
- Any other applications with the same as or similar complexity or reliability to the applications set forth above.